BFR92AW

NPN 5 GHz wideband transistor

Rev. 03 — 12 March 2008

Product data sheet

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NXP Semiconductors



FEATURES

- High power gain
- Gold metallization ensures
 excellent reliability
- SOT323 (S-mini) package.

APPLICATIONS

It is designed for use in RF amplifiers, mixers and oscillators with signal frequencies up to 1 GHz.

DESCRIPTION

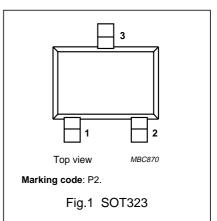
Silicon NPN transistor encapsulated in a plastic SOT323 (S-mini) package. The BFR92AW uses the same crystal as the SOT23 version, BFR92A.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	

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Product specification



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-	20	V
V _{CEO}	collector-emitter voltage	open base	-	-	15	V
I _C	collector current (DC)		-	-	25	mA
P _{tot}	total power dissipation	up to T _s = 93 °C; note 1	-	-	300	mW
h _{FE}	current gain	I _C = 15 mA; V _{CE} = 10 V	65	90	135	
C _{re}	feedback capacitance	$I_{C} = 0$; $V_{CE} = 10$ V; f = 1 MHz; $T_{amb} = 25 \ ^{\circ}C$	-	0.35	-	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 10 V; f = 500 MHz	3.5	5	-	GHz
G _{UM}	maximum unilateral power gain	I_{C} = 15 mA; V_{CE} = 10 V; f = 1 GHz; T_{amb} = 25 °C	-	14	-	dB
		I_C = 15 mA; V_{CE} = 10 V; f = 2 GHz; T_{amb} = 25 °C	-	8	-	dB
F	noise figure	I_{C} = 5 mA; V_{CE} = 10 V; f = 1 GHz; $\Gamma_{s} = \Gamma_{opt}$	-	2	-	dB
Tj	junction temperature		-	-	150	°C

Note

1. T_s is the temperature at the soldering point of the collector pin.

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LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

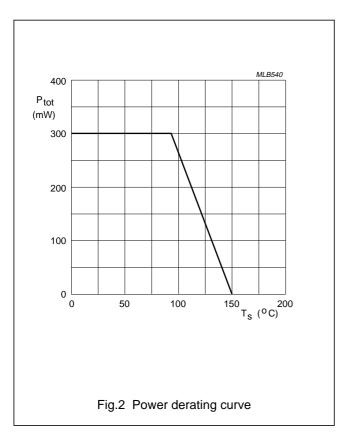
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CEO}	collector-emitter voltage	open base	-	15	V
V _{EBO}	emitter-base voltage	open collector	-	2	V
I _C	collector current (DC)		_	25	mA
P _{tot}	total power dissipation	up to $T_s = 93 \text{ °C}$; see Fig.2; note 1	-	300	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
	thermal resistance from junction to soldering point	up to T _s = 93 °C; note 1	190	K/W

Note to the Limiting values and Thermal characteristics

1. T_s is the temperature at the soldering point of the collector pin.



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CHARACTERISTICS

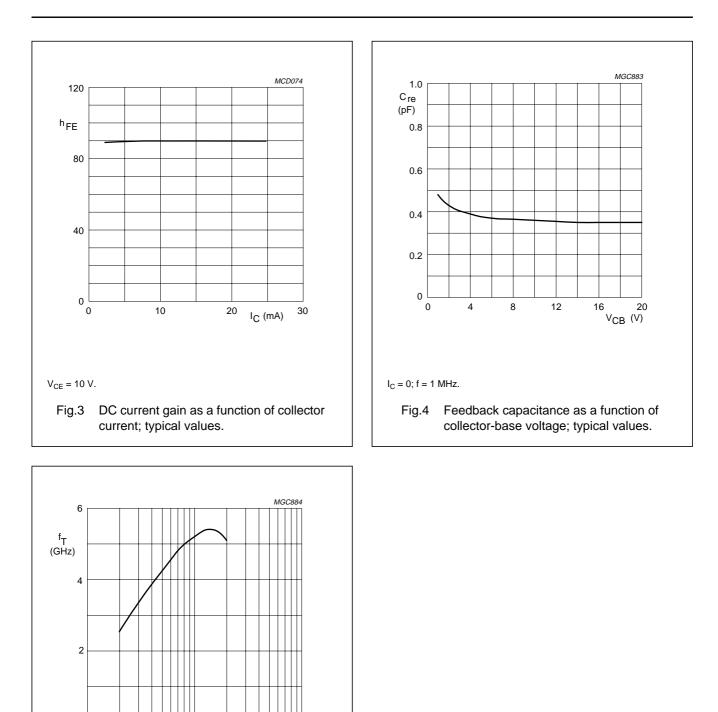
 $T_j = 25 \ ^{\circ}C$ (unless otherwise specified).

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector leakage current	I _E = 0; V _{CB} = 10 V	-	-	50	nA
h _{FE}	DC current gain	I _C = 15 mA; V _{CE} = 10 V	65	90	135	
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz	-	0.6	-	pF
Ce	emitter capacitance	$I_{C} = i_{c} = 0; V_{EB} = 0.5 V; f = 1 MHz$	-	0.9	-	pF
C _{re}	feedback capacitance	I _C = 0; V _{CE} = 10 V; f = 1 MHz	-	0.35	-	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 10 V; f = 500 MHz	3.5	5	-	GHz
G _{UM}	maximum unilateral power gain; note 1	I _C = 15 mA; V _{CE} = 10 V; f = 1 GHz; T _{amb} = 25 °C	-	14	-	dB
		I _C = 15 mA; V _{CE} = 10 V; f = 2 GHz; T _{amb} = 25 °C	-	8	-	dB
F	noise figure	$I_{C} = 5 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 1 GHz; $\Gamma_{s} = \Gamma_{opt}$	-	2	-	dB
		$I_{C} = 5 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 2 GHz; $\Gamma_{s} = \Gamma_{opt}$	-	3	-	dB

Note

1. G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1-|s_{11}|^2)(1-|s_{22}|^2)} dB$.

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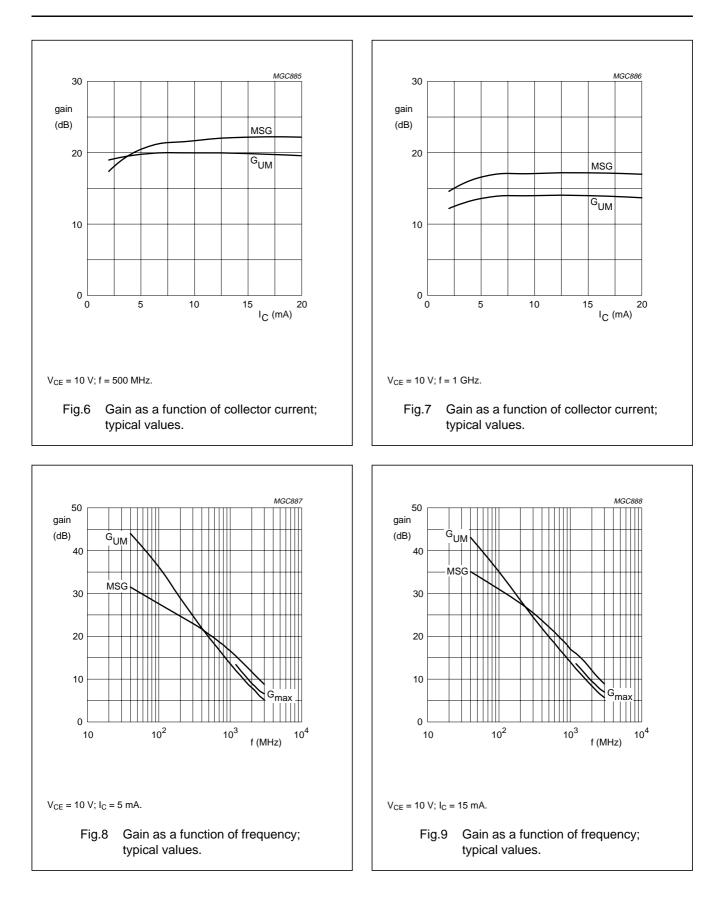
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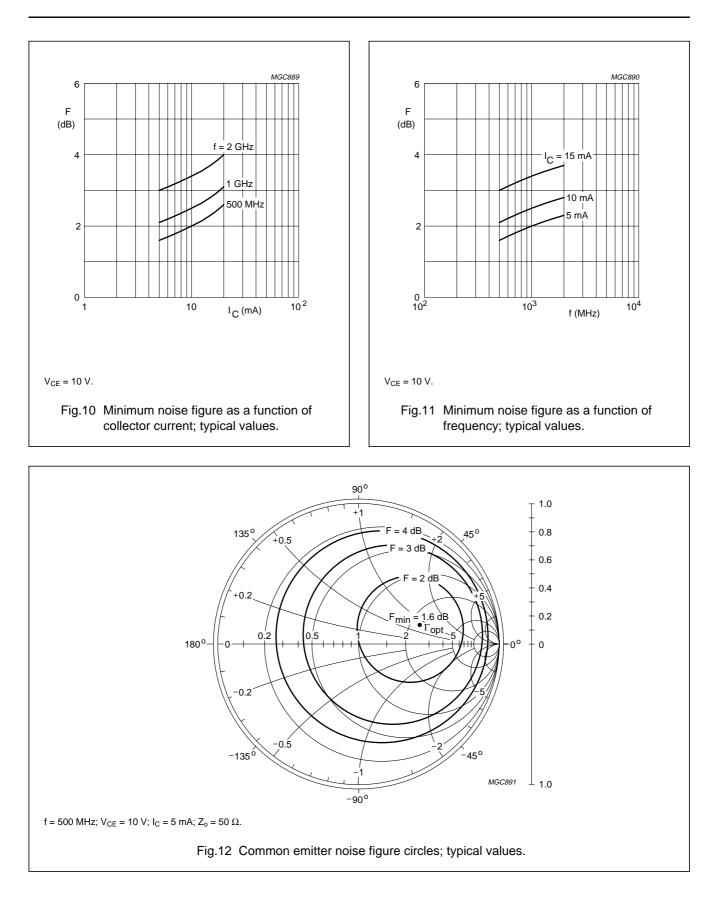
Fig.5 Transition frequency as a function of collector current; typical values.

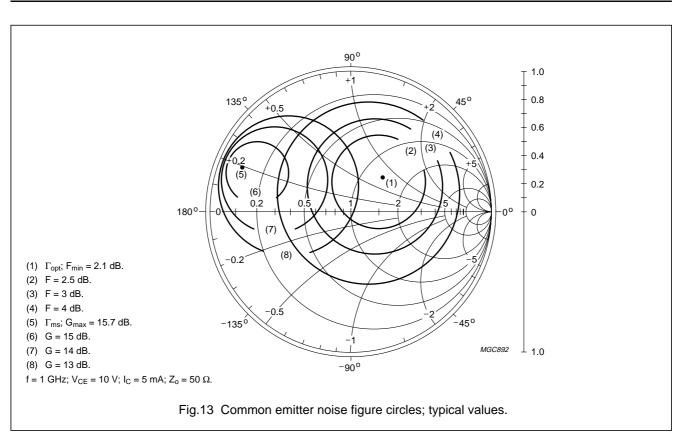
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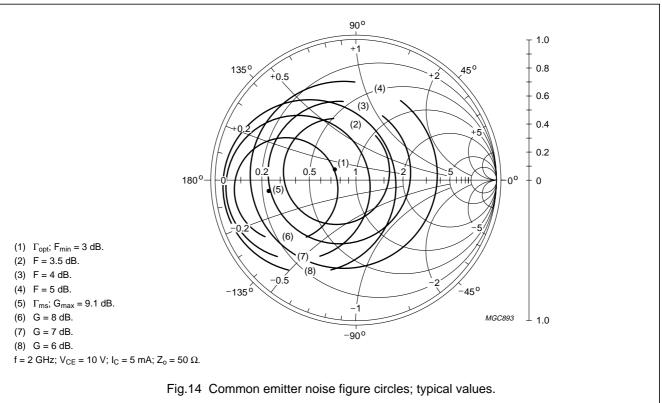
I_C (mA)

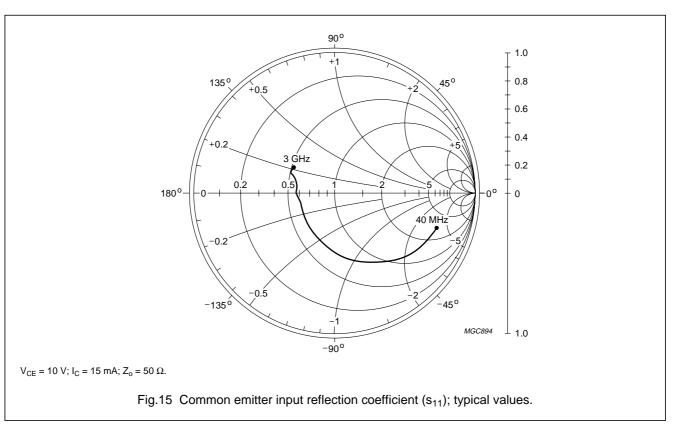
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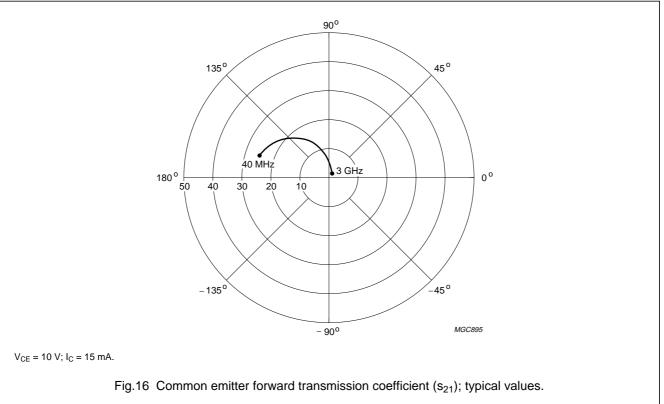


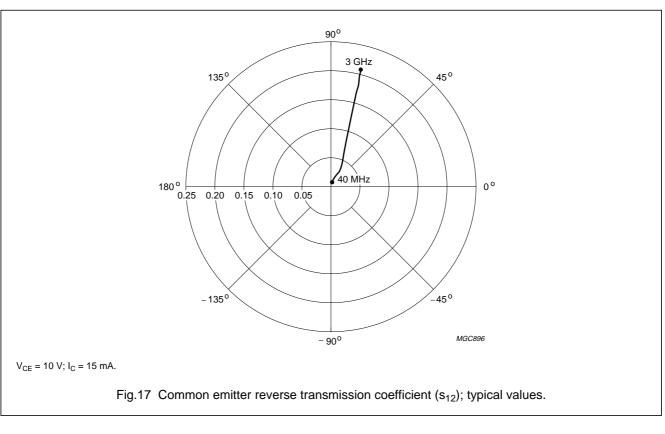


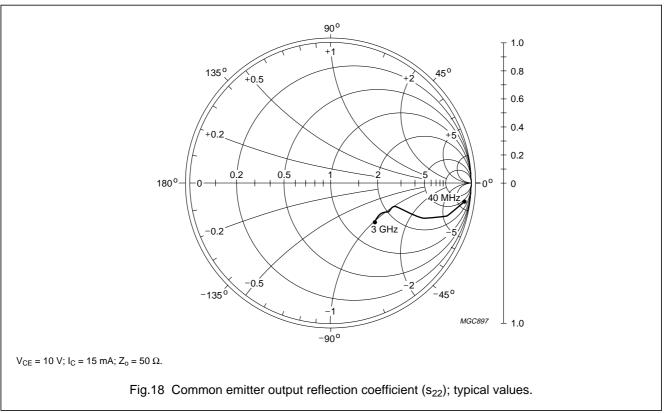






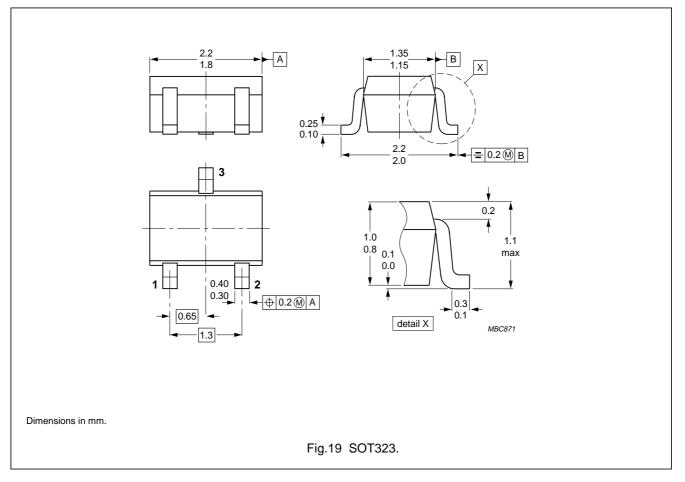






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PACKAGE OUTLINE



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Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Revision history

Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BFR92AW_N_3	20080312	Product data sheet	-	BFR92AW_2
Modifications:	 Quick refere 	ence data and Characteristic	cs Table; DC current ga	in value changed
BFR92AW_2	19950918	Product specification	-	BFR92AW_1
BFR92AW_1	19921001	-	-	-

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